

Chip Fuses

SURFACE MOUNT FUSES: 1206 SIZE → FAST ACTING

DESCRIPTION:



ALPS1206FXX is Fast acting for excessive current. Compatible with reflow and wave solder. Rugged ceramic and glass construction. Excellent environmental performance. RoHS Compliant, Lead Free & Halogen Free material

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FEATURES:

- Fast acting
- > 3.2mm× 1.6mm physical size
- Thick film manufacturing method, ceramic substrate, silver fusing element
- → -55°C~125°C operating temperature
- Excellent environmental integrity
- ➢ RoHS compliant
- Halogen-free

APPLICATIONS:

- Telecommunication: PDA / DSL
- Computers: LCD Panel / Printers / Laptop / Servers
- Consumer Electronics: DVD player / MP3MP4 Player

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ELECTRICAL SPECIFICATIONS

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Product Code	Current Rating	Voltage Rating		Interrupting Rating*	Resistance (ohms)** Typ.	Typical Melt I ² t*** DC (A ² s)	Typical Voltage Drop	Alpha Code Marking*****
AL DOLLOGOFOE	250m A	AC 22V	DC	AC/DC	4.1	0.0004	(V)****	D
ALPS1206F250	250mA	32V	63V	50A		0.0004	1.30	_
ALPS1206F375	375mA	32V	63V	50A	2.21	0.0008	0.93	E
ALPS1206F500	500mA	32V	63V	50A	1.5	0.0018	0.76	F
ALPS1206F750	750mA	32V	63V	50A	0.6	0.0055	0.68	G
ALPS1206F1	1A	32V	63V	50A	0.26	0.030	0.32	Н
ALPS1206F1.25	1.25A	32V	63V	50A	0.24	0.046	0.27	J
ALPS1206F1.5	1.5A	32V	63V	50A	0.12	0.083	0.19	K
ALPS1206F1.75	1.75A	32V	63V	50A	0.1	0.090	0.18	M
ALPS1206F2	2A	32V	63V	50A	0.072	0.110	0.19	N
ALPS1206F2.5	2.5A	32V	63V	50A	0.051	0.240	0.16	0
ALPS1206F3	3A	32V	63V	50A	0.038	0.255	0.16	Р
ALPS1206F3.5	3.5A	32V	32V	50A	0.025	0.280	0.14	R
ALPS1206F4	4A	32V	32V	50A	0.02	0.305	0.13	S
ALPS1206F4.5	4.5A	32V	32V	50A	0.017	0.395	0.12	X
ALPS1206F5	5A	32V	32V	50A	0.016	0.500	0.12	Т
ALPS1206F6	6A	32V	32V	50A	0.012	2.064	0.10	Υ
ALPS1206F7	7A	32V	32V	50A	0.01	2.720	0.10	U
ALPS1206F8	8A	32V	32V	50A	0.008	4.630	0.10	8

^{*}AC Interrupting Rating (Measured at rated voltage with a unity power factor); DC interrupting rating (Measured at rated voltage, time constant of less than 50 microseconds, battery source)

Device designed to carry rated current for four hours minimum. An operating current of 75% or less of rated current is recommended, with further derating required at elevated ambient temperatures.

ELECTRICAL CHARACTERISTICS				
ТҮРЕ	AMPER RATING	% of CURRENT RATING	OPENING TIME	
ALPS1206-F	250mA-8A	100%	4 Hours Minimum	
	250mA-8A	250%	5 Seconds Maximum	

ORDER INFORMATION

Specify Packaging and product code (i.e., ALPS1206FXX-TR)

ALP: Alpinesemi
S1206: Series Size
F: Fast Acting
XX: Ampere Rating

TR: 5,000 pieces of fuses on 8mm tape-and-reel on a 7-inch (178mm) reel per EIA Standard 481

^{**}DC Cold Resistance (Measured at 10% of rated current)

^{***} Typical Melting I2t (Measured with a battery bank at rated DC voltage, 10x-rated current, not to exceed IR, time constant of calibrated circuit less than 50 microseconds) (6A,7A &8A measured at interrupting rating)

^{****} Typical Voltage drop (measured at rated current after temperature stabilizes)



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PRODUCT CHARACTERISTICS

ITEM	TEST CONDITION/ METHODS	PERFORMANCE	STANDARD
Time/Current	100% of current rating	No Fusing, 4hours Min.	UL248-14
	250% of current rating	0.5A ~ 0.75A: ≤20sec	ALP SPEC.
		1.0A ~ 7.0A: ≤5sec	
	1000% of current rating	>0.1ms	IEC60127-4
Voltage Drop	100% of current rating	Deviation between the	IEC60127-4
		mean value: <15%	
Temperature Rise	100% of current rating	△T <75°C	IEC60127-4
Endurance Test	100 cycles of 1In for 1h "ON", for	△R : <10%	IEC60127-4
	15min "OFF", then following by 1h		
	at 125%In		
Interrupting Ability	0.5A ~ 3.5A: 50A 32V DC	without permanent arcing,	UL248-14
	4.0A ~ 7.0A: 35A 32V DC	ignition, and bursting of	IEC60127-4
		fuse link	
Solderability	240°C ±5°C, 3sec ±0.5sec	95% coverage Min.	IEC60127-4
			MIL-STD-202
			Method 208
Resistance to Soldering	260°C ±5°C, 10sec ±0.5sec	△R : <10%	MIL-STD-202 Method 210
		Legible appearance	
Bending Test	Distance between holding points:	△R :<10%	IEC60127-4
	90mm	No mechanical damages	
	Bending: 1mm, time: 10sec		
High Temperature	T=70°C ±2°C, 60%In, 96hours	△R : <10%; No fusing	MIL-STD-202 Method 108
Operating Life		14.51.4004	1444 CTD 000 14 14 1400
Humidity (Steady State)	T=40°C ±2°C, 90% ~ 95%RH,	△R : <10%	MIL-STD-202 Method 103
	1000hours	14.51.4004	15050050.0.1
Low Temperature Storage	T=-55°C ±3°C,96hours	∆R :<10%	IEC60068-2-1
High Temperature Storage	T=125°C±2°C,96hours	△R : <10%	IEC60068-2-2
Salt Spray	5% salt solution,48hours	△R : <10%	MIL-STD-202 Method 101
		Legible appearance	
Thermal Shock	100 cycles between -65°C / +125°C	△R : <10%	MIL-STD-202 Method 107
	60 minutes, each extreme	No mechanical damages	

TYPICAL DEVICE CHARACTERISTICS CURVES

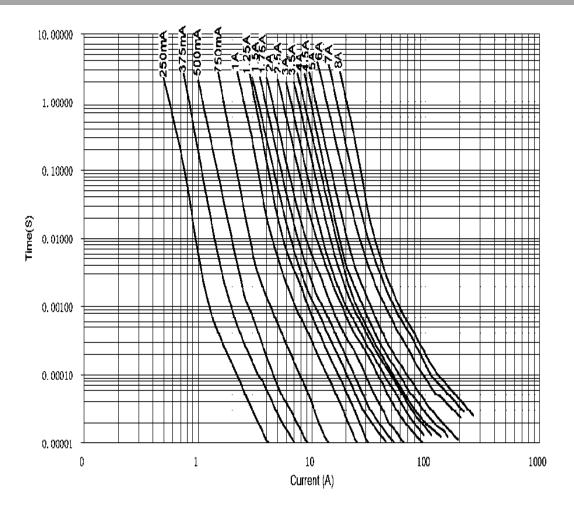
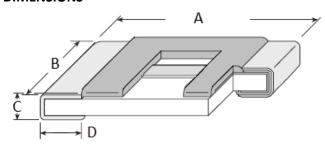


Fig1: TIME CURRENT CURVE

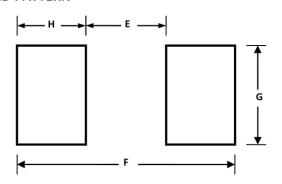


PACKAGE INFORMATION

DIMENSIONS



LAND PATTERN



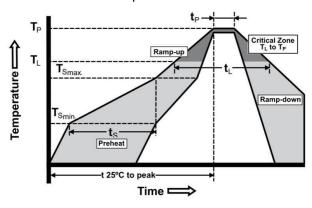
OUTLINE DIMENSIONS (mm)		
SYMBOL	MAX	
А	3.2±0.2mm	
В	1.6±0.2mm	
С	0.55±0.2mm	
D	0.5±0.25mm	
Е	2.00±0.30mm	
F	4.40±0.50mm	
G	2.40±0.30mm	
Н	1.20±0.30mm	

RECOMMENDED SOLDER CURVE

Reflow Soldering:

• Temperature: 260°C • Time: 30 sec Max.

• Recommend Reflow profile



Profile Feature	Pb Free Assembly
Average Ramp-up	3°C sec Max.
Rate (Ts _{max} to Tp)	5 C Sec Iviax.
Preheat	
Temperature Min. (Ts _{min})	150°C
Temperature Max. (Ts _{max})	200°C
Time (Tsmin toTsmax)	60sec ~ 120sec
Peak Temperature (Tp)	260°C
Time within 5°C of actual	20sec
Peak Temperature(tp)	
Melting tin time(t₁)	60sec ~ 150sec
Ramp-down Rate	6°C /sec Max.
Time 25°C to peak	8minutes Max.
Temperature	

Wave soldering

Reservoir Temperature: 260°C Time in Reservoir: 10sec Max.

Hand Soldering

Temperature: 350°C Time: 5sec Max.



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CUSTOMER NOTE:

DISCLAIMER

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- 1. ALPINESEMI™ Semiconductor Devices are RoHS compliant and hence customers are requested to dispose as per the prevailing Environmental Legislation put forth in their specific country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).



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